



# ICMSSM2020

## 2020 6<sup>th</sup> International Conference on Mechanical Structures and Smart

July 25-26, 2020

Ho Chi Minh City, Vietnam

The aim of ICMSSM2020 is to provide a platform for researchers, engineers, and academicians, as well as industrial professionals, to present their research results and development activities in Mechanical Structures and Smart Materials Related Issue.

### [Publication]

Papers submitted to ICMSSM2020 will be reviewed by technical committees of the conference. All accepted and registered papers will be published in "Materials Science Forum" [ISSN print 0255-5476 ISSN cd 1662-9760 ISSN web 1662-9752, Trans Tech Publications]. And the press will submit all papers to major databases such as **EI Compendex, Scopus and Scholar...**

You can attend the conference as a **listener, presenter** (for poster) or **author** (for **full paper**).

### Topics (not limited to)

- T1: Smart materials
- T2: Material Science and Engineering
- T3: Mechanical engineering and mechatronics
- T4: Materials Manufacturing and Processing

For more topics, please click:

<http://www.icmssm.org/pages/cfp.html>

### Paper Submission

1. Submit by CMT system : <https://cmt3.research.microsoft.com/ICMSSM2020>
2. Email: [cfp@icmssm.org](mailto:cfp@icmssm.org)

### Important Dates

Submission Deadline: April 20, 2020

Registration Due: April 27, 2020

Acceptance Notification: April 23, 2020

Conference Date: July 25-26, 2020

### History



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